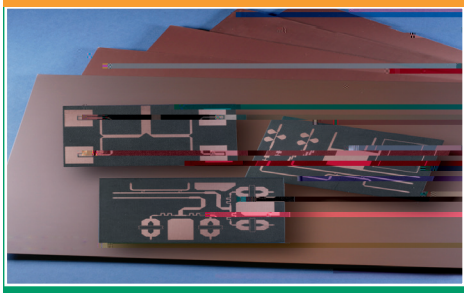
CORPORATION

Data Sheet





Features:

Some Typical Applications:

Its low dissipation factor extends the usefulness of RT/duroid 5870 and 5880 laminates to Ku-band and above.

RT/duroid 5870 and 5880 laminates are easily cut, sheared and machined to shape. They are resistant to all solvents and reagents, hot or cold, normally used in etching printed

may also be specifed.

When ordering RT/duroid 5870 and 5880 laminates, it is important to specify dielectric thickness, tolerance, rolled, electrodeposited or reverse treated copper foil, and weight of copper foil required.

Advanced Connectivity Solutions
100 S. Roosevelt Avenue, Chandler, AZ 85226
Tel: 480-961-1382 Fax: 480-961-4533 www.rogerscorp.com

S	S S	S C C	-S C C
0.005" (0.127mm) 0.031" (0.787mm) 0.010" (0.254mm) 0.062" (1.575mm) 0.015" (0.381mm) 0.020" (0.508mm) Non-standard thicknesses are available	18" X 12" (457 X 305mm) 18" X 24" (457 X 610mm) Non-standard sizes may be available up to 18" X 48" (457 X 1219 mm)	½ oz. (18µm) and 1 oz. (35µm) electrodeposited and rolled copper foil	¼ oz. (9 µm) electrodeposited copper foil ½ oz. (18µm), 1 oz. (35µm) and 2 oz. (70µm) reverse treat copper foil 2 oz. (70µm) electrodeposited and rolled copper foil
		Thick metal claddings may be available based on dielectric and plate thickness. Contact customer service for more information on available non-standard and custom thicknesses, claddings and panel sizes	

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